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To: Examiner Thanh Y. Tran	Total Pages Sent: 10
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Facsimile Number: 571-273-8300	Transmission Date: February 3, 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Lian, et al. Docket No.: 2004P51100US/
INTECH 3.0-050DIV

Serial No: 10/803,363 Art Unit: 2822

Date Filed: March 17, 2004


Title: Adhesion Layer on SiO₂ and Method

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 571-273-8300 on the date shown above:

- Certification of Facsimile Transmission (1 page)
- Amendment After Final Rejection (9 pages)

Respectfully submitted,


Adrienne Marie Jamies
Legal Assistant

Confirmation Respectfully Requested

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Examiner: Thanh Y. Tran

Mail Stop: AF
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's Office Action mailed December 29, 2005, Prior to the consideration of the application, please further amend the above-referenced application as follows:

2004P51100US/
INTECH3.0-050DIV

Page 1 of 9

Amendment After Final

In the Title:

Please amend the title on page 1 as follows:

Adhesion Layer ~~for Pt~~ on SiO₂ and Method